



Edition 2.0 2015-08

TECHNICAL REPORT



Integrated circuits – Measurement of electromagnetic emissions – Part 1-1: General conditions and definitions – Near-field scan data exchange format

> <u>IEC TR 61967-1-1:2015</u> https://standards.iteh.ai/catalog/standards/sist/9ac28efb-3bbb-40b8-8449-87a296c83783/iec-tr-61967-1-1-2015





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IEC TR 61967-1-1:2015 https://standards.iteh.ai/catalog/standards/sist/9ac28efb-3bbb-40b8-8449-87a296c83783/iec-tr-61967-1-1-2015

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CONTENTS

FC	REWO	RD	5
IN	TRODU	CTION	7
1	Scop	e	8
2	Norm	ative references	8
3	Term	s, definitions and abbreviations	8
	3.1	Terms and definitions	
	3.2	Abbreviations	
4	-	ral syntax rules and guidelines	-
	4.1	General	
	4.2	XML requirements	
	4.2.1	•	
	4.2.2		
	4.2.3		
	4.2.4		
	4.2.5	Comments	. 10
	4.2.6	Line terminations	. 10
	4.2.7	Element hierarchy	. 10
	4.3	Element hierarchy. Keyword requirements TANDARD PREVIEW	11
	4.3.1		
	4.3.2	General	. 11
	4.3.3		. 11
	4.3.4	Root element keywordstatog/standards/sist/9ac28cfb-3bbb-40b8-8449	. 12
	4.4	File structure	
	4.4.1	General	. 12
	4.4.2	File names	. 12
	4.4.3	File paths	. 12
	4.4.4	Single XML file	. 12
	4.4.5	Multiple XML files	. 12
	4.4.6	Separate data files	. 13
	4.4.7	Additional files	. 13
	4.4.8	File compression	. 13
	4.5	Values	. 14
	4.5.1	General	
	4.5.2	5	
	4.5.3	5	
	4.5.4	5	
	4.5.5		
	4.6	Coordinate systems	
	4.6.1	General	
	4.6.2		
	4.6.3	5	
	4.6.4		
	4.6.5		
	4.6.6	5	
	4.7	Field type and orientation	
	4.8	Data syntax	. 24

4.8.1		General	.24
4.8.2		Data arrangement	. 24
4.8.3		Data with coordinate information	.25
4.8.4		Data without coordinate information	.25
4.8.5		Data format	.26
4.8.6		Data notation	.26
4.9	Prob	be factor	. 28
4.10	Imag	ges	. 30
4.10.	1	General	. 30
4.10.	2	Image file types	. 30
4.10.	3	Image file name and path	. 30
4.11	3D c	objects	. 30
4.11.	1	General	. 30
4.11.	2	3D object file types	. 30
4.11.	3	3D object file name and path	. 30
4.11.	4	3D map object file name and path	. 30
Annex A (infor	mative) Example files	. 31
A.1	Mini	mum default file	. 31
A.1.1		Example file	. 31
A.1.2	2	Default value description	.31
A.2	File	with magnitude and angle data RD PREVIEW	. 32
A.2.1		Example file	
A.2.2			
A.3	File	with field azimuth and zenith orientation	. 33
A.3.1		Example/filedards.iteh.ai/catalog/standards/sist/9ac28efb-3bbb-40b8-8449	. 33
A.3.2	2	Default value description3.783/iec-tr-61967-1-1-2015	
A.4	File	with optimised field azimuth orientation	
A.4.1		Example file	
A.4.2		Default value description	. 34
A.5	File	with piece-wise linear time domain data in a separate binary file	.35
A.5.1		Example file	. 35
A.5.2	2	Default value description	
A.6	File	without coordinate information	. 35
A.6.1		Example file	
A.6.2	2	Default value description	. 36
A.7	File	for immunity scan with multiple criteria	. 36
A.7.1		Example file	. 36
A.7.2	2	Default value description	. 37
A.8	File	for emission scan with probe factor	. 38
A.8.1		Example file	. 38
A.8.2	2	Default value description	. 38
A.9	File	for immunity scan with probe factor	. 39
A.9.1		Example file	
A.9.2	2	Default value description	. 39
A.10	File	with image and 3D image	.40
A.10.	.1	Example file	.40
A.10.	.2	Default value description	.40
A.11	File	with plane rotation	.41
A.12	Emis	ssion scan in several XML files	.42

Annex B ((normative) Valid keywords	44
B.1	General	44
B.2	File header keywords	44
B.3	Global keywords	44
B.4	Component section keywords	
B.5	Setup section keywords	45
B.6	Probe section keywords	
B.7	Data section keywords	
	(normative) Keyword usage rules	
Bibliograp	bhy	63
	Multiple XML files	10
-	- Multiple XML files	
-	- XML files with data files	
-	- Additional files	
Figure 4 -	- Right-hand Cartesian coordinate system	17
Figure 5 -	- Left-hand Cartesian coordinate system	17
Figure 6 -	- Cylindrical coordinate system	18
Figure 7 -	- Spherical coordinate system	19
Figure 8 -	- Offsets and image positioning (right-hand Cartesian)	20
Figure 9 -	 Offsets and image positioning (right-hand Cartesian) Offsets and image positioning (left-hand Cartesian) 	21
	- Field orientation - Right hand Cartesian coordinate system	
Figure 12	- Field orientation - Left-hand Cartesian coordinate system	22
Figure 13	- Field orientation - Gylindrical coordinate system-3bbb:40b8-8449	23
	- Field orientation - Spherical coordinate system 015	
-	1 – Example .obj file	
	2 – Coordinates in DUT reference plane	
-	3 – Coordinates in the measurement reference plane	
0		
Table 1 –	Valid logarithmic units	
Table 2 –	Relationship between azimuth, zenith angles and field component	24
Table 3 –	Permitted values for the keyword: Coordinates	25
	Order of measurement points when coordinates are not included	
Table 5 –	Probe factor linear units	
Table 6 –	Probe factor logarithmic units	29
Table A.1	– Data matrix	
	– Magnetic field strength for emission	
Table A.3	– Magnetic field strength for immunity	
Table C.1	- File header keywords	49
Table C.2	2 – Global keywords	50
Table C.3	- Component section keywords	51
	– Setup section keywords	
	 Probe section keywords 	
	Data section keywords	
	· · · · · · · · · · · · · · · · · · ·	

INTERNATIONAL ELECTROTECHNICAL COMMISSION

INTEGRATED CIRCUITS – MEASUREMENT OF ELECTROMAGNETIC EMISSIONS –

Part 1-1: General conditions and definitions – Near-field scan data exchange format

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IEC TR 61967-1-1, which is a technical report, has been prepared by subcommittee 47A: Integrated circuits, of IEC technical committee 47: Semiconductor devices.

This second edition cancels and replaces the first edition published in 2010. This edition constitutes a technical revision.

This edition includes the following significant changes with respect to the previous edition:

• Addition of:

- 4.11 3D objects;
- Binary data files;
- Piece-wise linear time domain and frequency domain data;
- Vectors permitting rotation and offset of measurement and DUT reference planes;
- Transducer gain and probe factor can be complex;
- New keywords: Object3d, Mapobj, Maxhold, Datafileformat, Vx, Vy, Vz, Target, Software, Data_source.
- Updating of:
 - 4.9 Probe factor and corresponding keywords.
- Modification of:
 - Keywords: Average.

The text of this technical report is based on the following documents:

Enquiry draft	Report on voting	
47A/953/DTR	47A/962/RVC	

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 61967 series, under the general title Integrated circuits – Measurement of electromagnetic emissions, can be found on the IEC website. IEC TR 61967-1-12015

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the the the stability date indicated on the the the stability date indicated on the the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

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INTRODUCTION

Near-field scan measurements, as described for example in IEC TS 61967-3 [1] ¹ or IEC TS 62132-9 [2], and simulations generate a large amount of data. Many different formats are used for storing the data, thereby rendering its exchange extremely difficult.

The proposed format is intended to facilitate exchange of near-field scan data between industrials, academics, EDA tool vendors and end customers. It is based on the well-known XML format, which is both machine and human readable. Its structure allows the files to be generated and processed on any operating system. In order to limit the file size, it is possible to store the information and data in a single file or multiple files. Moreover, the ASCII-based XML format allows the files to be compressed to a very high level with readily available compression software.

The three conventional coordinate systems (Cartesian, cylindrical and spherical) are supported by the proposed exchange format. Information on the device under test, the test set-up, the probe, etc., is also included in the files. Notes and links to external documents allow complex test environments to be well described.

The version of the exchange format described in this technical report is 2.0. Future revisions will add items, such as new keywords and rules, considered to be "enhancements" to Version 1.0. Consequently, all future revisions will be considered supersets of Version 2.0, allowing backward compatibility.

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¹ Figures in square brackets refer to the Bibliography.

INTEGRATED CIRCUITS – MEASUREMENT OF ELECTROMAGNETIC EMISSIONS –

Part 1-1: General conditions and definitions – Near-field scan data exchange format

1 Scope

This part of IEC 61967 provides guidance for exchanging data generated by near-field scan measurements.

The described exchange format could also be used for near-field scan data generated by simulation or computation software. It should be noted that, although it has been developed for near-field scan, its use is not restricted to this application. The exchange format can be applied to emission and immunity near-field scan data in the frequency and time domains.

The scope of this technical report includes neither the methods used for the measurements or simulations, nor the software and algorithms used for generating the exchange file or for processing or viewing the data contained therein.

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2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, structure, including any amendments) applies. 87a296c83783/iec-tr-61967-1-1-2015

IEC 60050 (all parts), International Electrotechnical Vocabulary (available at http://www.electropedia.org)

IEC 61967-1, Integrated circuits – Measurement of electromagnetic emissions, 150 kHz to 1 GHz – Part 1: General conditions and definitions

ISO 8879, Information processing – Text and office systems – Standard Generalized Markup Language (SGML)

ANSI INCITS 4:1986, Information Systems – Coded Character Sets – 7-Bit American National Standard Code for Information Interchange (7-Bit ASCII)

IEEE Std 754[™]-2008: *IEEE Standard for Floating-Point Arithmetic*

3 Terms, definitions and abbreviations

3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 61967-1, IEC 60050-131 [3] and IEC 60050-161 [4], as well as the following, apply.

3.1.1

section

XML element placed one level below the root element or within another section, and that contains one or more XML elements, but no value

3.1.2

parent

keyword, one level above another keyword (child)

3.1.3

child

keyword, one level below another keyword (parent)

3.1.4

probe factor

ratio of electric or magnetic field strength at a specified location in near-field evaluation to the signal level measured at the output connection or applied to the input connection of a probe

[SOURCE: IEC 61967-3:2014, 3.1.2]

3.2 Abbreviations

- EDA Electronic Design Automation
- NFS Near-Field Scan
- XML eXtensible Markup Language

SGML Standard Generalized Markup Language DPREVIEW

4 General syntax rules and guidelines

IEC TR 61967-1-1:2015

4.1 General https://standards.iteh.ai/catalog/standards/sist/9ac28efb-3bbb-40b8-8449-

The following rules and guidelines ensure that files intended for exchange will be correctly recognised and processed by viewers and processors. Examples of XML files conforming to the present exchange format are given in Annex A.

4.2 XML requirements

4.2.1 General

This exchange format uses XML 1.0 fourth edition to structure the information. XML shall conform to the standard generalized markup language (SGML) (ISO 8879).

The rules below ensure that the NFS files can be parsed correctly by an NFS parser.

4.2.2 XML declaration

Although the XML declaration is optional in an XML file, the NFS file should include an XML declaration, dedicated to basic XML parsers. An NFS file parser does not interpret this header.

A file header example is given below:

<?xml version="1.0" encoding="UTF-8"?>

The XML declaration shall be the first line of the file.

4.2.3 XML elements

All information is saved in the form of XML elements. Each element starts with a start-tag and ends with an end-tag. The start-tag consists of a keyword enclosed in triangular brackets, "<Keyword>". The end-tag consists of the same keyword prefixed by the character "/" and

enclosed in brackets, "</Keyword>". Content in the form of text is enclosed by a start-tag and an end-tag.

An example of an element is given below:

<keyword></keyword>	</th <th>start-tag></th>	start-tag>
text	</td <td>content></td>	content>
	< !	end-tag>

It is also allowed to write an element on the same line, for example, to include short content.

<Keyword>text</Keyword>

The contents of an element may consist of one or more other elements or a value (numerical, or alphanumerical). For clarity, tab characters may be used for indenting. Except when used for surrounding keywords, triangular brackets "<" and ">" shall not be part of content.

An empty element may be included to indicate that a particular keyword exists, but has no content:

<empty element/>

4.2.4 Root element

The XML file shall contain one, and only one, root element. It encloses all the other elements and is therefore the sole parent element to all the other elements. The start-tag of the root element is placed at the beginning of the file of after the XML declaration when present. The end-tag of the root element is at the last entry of the file.

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4.2.5 Comments:tps://standards.iteh.ai/catalog/standards/sist/9ac28efb-3bbb-40b8-8449-

87a296c83783/iec-tr-61967-1-1-2015 Comments may be inserted into the file between "<!--" and "-->". An example is given below:

<!-- this line is a comment -->

Comments can be inserted anywhere in the file, except inside start- and end-tags, and written on a single line or on several lines. All text enclosed by comment brackets is considered as a comment and may be ignored.

4.2.6 Line terminations

In order to facilitate readability, it is usual to organise the file into lines. The line termination sequence shall be either a linefeed character or a carriage return character followed by a linefeed character.

4.2.7 **Element hierarchy**

The order of the elements is not important, but their hierarchy shall be respected.

example layout:

```
<Keyword1> ... </Keyword1>
<Keyword2>
     <Keyword21> ... </Keyword21>
     <Keyword22> ... </Keyword22>
</Keyword2>
<Keyword3> ... </Keyword3>
```

An acceptable equivalent layout of the example:

```
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```

```
<Keyword3> ... </Keyword3>
<Keyword1> ... </Keyword1>
<Keyword2>
<Keyword22> ... </Keyword22>
<Keyword21> ... </Keyword21>
</Keyword2>
```

In this layout the order is changed, but the hierarchy is respected.

An unacceptable layout of the example:

```
<Keyword2> ... </Keyword2>
<Keyword22> ... </Keyword22>
<Keyword21> ... </Keyword21>
<Keyword3>
<Keyword1> ... </Keyword1>
</Keyword3>
```

In this layout the hierarchy is not respected.

4.3 Keyword requirements

4.3.1 General

Keywords, placed in start- and end-tags, are used to introduce descriptions, values and sections that are specific to NFS measurements and simulations. A list of keywords is given in Annex B and a more detailed description of each keyword is given in Annex C.

Keywords for sections with the **Root element as parent, such as** Component, Setup and Probe, shall only appear once in an XML file or a group of XML files (see 4.4.5). However, an XML file or a group of XML files (see 4.4.5) may contain several data sections. This allows the measurements on a component using, for example different lists of frequencies or coordinate offsets, to be included in the same XML file or group of XML files.

Some keywords, such as Frequencies, Unit, List, etc., may be present in several sections.

A parent keyword is required when a child keyword is present.

The rules below ensure that the file can be correctly parsed by an NFS parser.

4.3.2 Keyword characters

Only ASCII characters, as defined in ANSI INCITS 4:1986, shall be used in the files. The use of characters with codes greater than hexadecimal 07E is not allowed. Also, ASCII control characters (those numerically less than hexadecimal 20) are not allowed, except for tabs or in a line termination sequence. For example, the "°" character (ASCII 176) is not permitted. Only alphabetical or numerical characters can be used to write keywords. Spaces are not permitted. If needed, the underscore "_" character can separate the parts of a multi-word keyword.

4.3.3 Keyword syntax

The content of the files is case sensitive. All keywords shall be written in lower case starting with an upper case letter.

4.3.4 Root element keywords

As described in 4.2.4, all elements of the file shall be enclosed within the root element. The following keywords are reserved for root elements and shall not be used for any other purposes in the file:

EmissionScan

ImmunityScan

If the proposed XML file format is used for other applications, other keywords may be used in the root element, but NFS parsers may not be able to parse the file.

4.4 File structure

4.4.1 General

The information to be exchanged may be stored in a single XML file or in several XML and data files. The following rules and guidelines ensure that the files can be correctly located by an NFS parser.

4.4.2 File names

4.4.3

To facilitate portability between operating systems, file names should have a base name of no more than forty characters followed by a period ".", followed by a filename extension of no more than three characters. The file name and extension shall use characters from the set (space, " ", 0x20 is not included): **IANDARD PREVIEW**

(standards.iteh.ai) a b c d e f g h i j k l m n o p q r s t u v w x y z 0 1 2 3 4 5 6 7 8 9 - is i # s s - { }) (@ '` https://standards.iteh.ai/catalog/standards/sist/9ac28efb-3bbb-40b8-8449-File paths 87a296c83783/iec-tr-61967-1-1-2015

In order to ensure portability and compressibility, only relative paths can be used to define a path name. An absolute path is not exportable and is not permitted. The relative path shall start with "./" to indicate that the path name of the picture file will be appended to the path of the current XML file. It is not permitted to browse to a higher level from the current XML path (e.g. by using "../"). A file name without "./" is assumed to be located in the same directory as the current XML file.

4.4.4 Single XML file

When the information is contained in a single XML file, it shall conform to the rules and guidelines applicable to XML files, as described in 4.2.

Data is included in the Data section of the file within the XML element using the keyword: List and shall be stored in ASCII form. When binary data is to be stored, it shall be included in separate data files as described in 4.4.6.

4.4.5 Multiple XML files

The XML document is divided into several sections having the root element as parent. Such a section contains information on a particular part of the NFS environment and is defined by keywords such as Component, Setup, Probe and Data. Each XML file may contain one or more sections and shall conform to the rules and guidelines applicable to XML files as described in 4.2 and 4.3.1. An example of multiple XML files is given in Clause A.12.

In order to ensure portability and compressibility, all the XML files shall be placed in the same directory, as shown in Figure 1. The NFS parser shall parse all the XML files that are in the main directory.

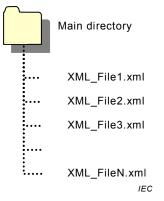


Figure 1 – Multiple XML files

4.4.6 Separate data files

Information may be contained in a single file or multiple XML files and the data contained in one or more additional data files. XML files shall conform to the rules and guidelines applicable to XML files, as described above and in 4.2. Data files shall contain only lines of data as described in 4.8. The names and paths of the data files are defined by the keyword: Data_files and shall conform to 4.4.2 and 4.4.3.

The information contained in the data file(s) may be stored in ASCII form for human readability or in binary form Binary data shall conform to the binary32 interchange floating-point format described in IEEE Std 754TM-2008. This 32-bit format includes 1 sign bit, an 8 bit biased exponent and a 23 bit trailing significant field. The format of the data files is specified by the keyword: Datafileformat. If the keyword: Datafileformat is empty or absent, it is assumed that the data is stored in ASCII form_AII data files shall use the same data format.

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In order to ensure portability and compressibility, the data files shall be placed either in the same directory as the XML files or in a sub-directory located at the same level or a lower level as the XML files, as shown in Figure 2. It is not permitted to locate the additional files at a higher level than the XML files.

4.4.7 Additional files

An XML file may contain references to other files such as image files (Keyword: Image) and document files (Keyword: Documentation). In order to ensure portability and compressibility, these additional files shall be placed either in the same directory as the single XML file or in a sub-directory located at the same level or a lower level as the XML files, as shown in Figure 3. It is not permitted to locate the additional files at a higher level than the XML files.

4.4.8 File compression

When compressing the file system, care shall be taken to include the paths of the various XML and data files in the compressed file. This ensures that, when decompressed, the file structure is conserved. The paths are not required when all files are stored in the same directory.

NOTE The most common compression used is the .ZIP File Format [5]. When the various XML and data files are compressed using the .ZIP File Format, the extension may be .nfs.